CONTENTS

1.	The Present State of Metallized Polyimide	1
	SURFACE ANALYSIS TECHNIQUES	
2.	Photoelectron Spectroscopies Applied to Polymer – Metal Interactions	10
3.	Using Near-Edge soft X-Ray Absorption Spectroscopy To Study Organic Polymers and	
	Metal – Polymer	36
4.	High-Resolution Electron Energy Loss Spectroscopy: Application to Polymer Surfaces	
	and Polymer – Metal	47
5.	Plasma- and Corona-Modified Polymer Surfaces: Characterization by Static Secondary	
	Ion Mass Spectrometry	60
6.	Depth Profiles on Thin Films and Interfaces by the Elastic Recoil Detection Technique	88
7.	Quantitative Trace Element Analysis by Proton-Induced X-ray Emission	110
8.	Trace Element Determination in Polymers by Neutron Activation	128
	SURFACE MORPHOLOGY AND MODIFICATION	
9.	Morphology of Polymer Chains by Transmission Electron Microscopy	136
10.	Polymer Surface Modification by Dual-Frequency Plasma Treatment	147
11.	Polyimide Surface Degradation: X-ray Photoelectron Spectroscopic Study Under	
	UV-Pulsed Laser Irradiation	161
12.	Metal-Filled Polymers: Surface Modification by Plasma Deposition	170
13.	Wet-Process Surface Modification of Polyimides: Adhesion Improvement	179
14.	Sensitivity of Plasma Fluorinated Polyimide and Poly (tetrafluoroethylene) to High-Energy	
	Ion Beams During Rutherford Backscattering Spectroscopy	196
15.	Surface Analysis of Polymers by Ionic Spectrometries: X-ray Photoelectron Spectroscopy	
	Evaluation of Ion Bombardment Damages	210
16.	Thermal Stability of Electron-Irradiated Poly (tetrafluoroethylene): X-ray Photoelectron	
	and Mass Spectroscopic Study	223
17.	Novel Process for Surface Modification of Polyimide	235
	INTERFACIAL INTERACTIONS	
18.	Reactions of Metal Atoms with Monomers and Polymers	242
19.	Reactions of Metal Powders with Organic Polymers	265
20.	Reaction During the Sputtering of Metals onto Polyimide	272
21.	Aluminum-Polyester Corrosion: An X-ray Photoelectron Spectroscopic Study	288
22.	Metal-Polyimide Interfaces Characterized by Secondary Ion Mass Spectroscopy	297
23.	Model Systems for Polyimide-on-Copper Interface	312

24.	Polyimide-Copper Interface: Model Study Using Photoelectron Spectroscopy	333
25.	Aluminum-Polyimide Interface	344
26.	Solventless Polyamic Acid: Consequences for Reactivity with Metals	353
27.	Characterization of the Poly (ether ether Ketone)-Copper Interface: Preliminary Electron	
	Spectroscopy for Chemical Analysis	370
28.	Langmuir Blodgett Film-Metal Interfaces: Static Secondary Ion Mass Spectrometry and	
	Electron Spectroscopy for Chemical Analysis	379
29.	Redox Seeding and Electroless Metallization of Polyimides	394
	ADHESION	
30.	Adhesion of Metals to Thin-Film Fluorocarbon Polymers	416
31.	Polypropylene and Aluminum Adhesion: Improvement by N ₂ Low-Pressure Plasma	
	Treatment	423
32.	X-ray Photoelectron Spectroscopy of Modifies Polymer Surface and Metal-Polymer	
	Interfaces: Correlations with Adhesion	433
33.	Crystallographic Structure and Adhesion of Aluminum Thin Films Deposited on Mylar	453
34.	Chemical Bonding and Morphology of Interfaces in Aluminized Silicones from Evaporation	l
	and Sputtering	467
35.	Polyetherimide Surfaces Chemically Treated To Improve Adhesion to Electroless Copper	485
36.	Intrinsic Bond Strength of Metal Films on Polymer Substrates: A New Method of	
	Measurement	500
Aut	hor Index	515
Affiliation Index		516
Subject Index		516
	v .	